Docket No. JCLA3140

100847441



RECORDATION FORM COVER S 1-31-92 PATENTS ONLY	SHEET U.S. Department of Commerce Patent and Trademark Office				
To the Honorable Assistant Commissioner f					
original documents of the Name of conveying party(ies): Ming-Tsung Liu Tsung-Yuan Hung	Name/address of receiving Party(ies): United Semiconductor Corp.				
3. Nature of conveyance: ☐ Merger ☐ Security Agreement ☐ Other ☐ Change of Name ☐ Reassignment	No 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.				
3. Date(s) of execution: August 21, 1998;	Add'1 names of receiving parties Attached? Yes No				
5. Application number(s) or patent number(s)					
If this documents is being filed together with a new application, the execution date of the application is August 21, 1998					
A. Patent Application No. (s)	B. Patent No. (s)				
09 164789					
Additional numbers attached	? ☐ Yes ☒ No				
6. Name and address of party to whom correspondence concerning document	7. Total No. of applications and patents involved:				
should be mailed:	ONE(1) 8. Total fee (37 CFR §3.41); \$40.00				
J.C. Patents, Inc. 1340 Reynolds Ave., Suite 114	Enclosed				
Irvine, CA 92614 (949) 660-0761	Charge to Acct. No. 9. Total number of pages, including cover sheet, attachments and document 3.				
DO NOT USE TH	HIS SPACE				
10. Statement and Signature:	YOE				
To the best of my Knowledge and believed and correct and any attached copy is a true					
Jiawei Huang Name of Person Signing Signatu	Hung 10-1-98 To Date				
Provisional Registration No. P-43, 330					

10/08/1998 TTON11 00000148 09164288 01 FC:581

PATENT REEL: 9493 FRAME: 0668

ASSIGNMENT

WHEREAS, (1) Ming-Tsung Liu (2) Tsung-Yuan Hung

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: METHOD FOR FABRICATING A SHALLOW TRENCH ISOLATION STRUCTURE

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, United Semiconductor Corp., of No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

-1-

ASSIGNMENT CONTINUED

IN TESTIMONY Windicated.		, Assignor has/have signed his/her/their			
	MaNG - TSUN	14 L	IU.	1998/08/21	
Signature					
	Jang- year	Dang	Dn	4.21.188	
Signature	Jung- Gran		Ø	•	
Signature					
Signature		Arra Arra Arra Arra Arra Arra Arra Arra			

PATENT REEL: 9493 FRAME: 0670